

HALOGEN

FREE

1200 V Power SiC Gen 3 Merged PIN Schottky Diode, 20 A



LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | | |
|---|-------------|--|--|--|--|
| I _F | 20 A | | | | |
| V_{R} | 1200 V | | | | |
| V _F at I _F at 25 °C, typ. | 1.35 V | | | | |
| T _J max. | 175 °C | | | | |
| I _R at V _R at 175 °C | 12 µA | | | | |
| Q _C (V _R = 800 V) | 107 nC | | | | |
| Package | TO-247AD 2L | | | | |
| Circuit configuration | Single | | | | |

FEATURES

- Majority carrier diode using Schottky technology on SiC wide band gap material
- Improved V_F and efficiency by thin wafer technology
- Positive V_F temperature coefficient for easy paralleling
- Virtually no recovery tail and no switching losses
- · Temperature invariant switching behavior
- 175 °C maximum operating junction temperature
- MPS structure for high ruggedness to forward current surge events
- Meets JESD 201 class 1A whisker test
- Solder bath temperature 275 °C maximum, 10 s per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Wide band gap SiC based 1200 V Schottky diode, designed for high performance and ruggedness.

Optimum choice for high speed hard switching and efficient operation over a wide temperature range, it is also recommended for all applications suffering from Silicon ultrafast recovery behavior.

Typical applications include AC/DC PFC and DC/DC ultra high frequency output rectification in FBPS and LLC converters.

MECHANICAL DATA

Case: TO-247AD 2L

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

Mounting torque: 10 in-lbs maximum

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise specified) | | | | | | |
|---|--|--|-------------|------------------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V | | |
| Continuous forward current | I _F ⁽¹⁾ | T _C = 145 °C (DC) | 20 | ۸ | | |
| Continuous forward current | I _F ⁽²⁾ | T _C = 152 °C (DC) | 20 | Α | | |
| DC blocking voltage | V_{DC} | | 1200 | V | | |
| Repetitive peak forward current | I _{FRM} | T_C = 25 °C, f = 50 Hz, square wave, DC = 25 % | 90 | Α | | |
| | I _{FSM} | $T_C = 25$ °C, $t_p = 10$ ms, half sine wave | 180 | А | | |
| Non-repetitive peak forward surge current | | $T_C = 110 ^{\circ}\text{C}$, $t_p = 10 \text{ms}$, half sine wave | 148 | | | |
| | P _{tot} (1) | T _C = 25 °C | 188 | - w - w | | |
| Davies discipation | | T _C = 110 °C | 81 | | | |
| Power dissipation | P _{tot} (2) | T _C = 25 °C | 250 | | | |
| | | T _C = 110 °C | 108 | | | |
| I ² t value | c.2 | T _C = 25 °C | 162 | A ² s | | |
| | ∫i ² dt | T _C = 110 °C | 105 | A ^z S | | |
| Operating junction and storage temperatures | T _J ⁽³⁾ , T _{Stg} | | -55 to +175 | °C | | |

Notes

- (1) Based on maximum Rth
- (2) Based on typical Rth
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|----------------|--|------|------|------|-------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| | | I _F = 20 A | - | 1.35 | 1.5 | | |
| Forward voltage | V _F | I _F = 20 A, T _J = 150 °C | - | 1.73 | 2.0 | V | |
| | | I _F = 20 A, T _J = 175 °C | - | 1.85 | - | | |
| Reverse leakage current | I _R | $V_R = V_R$ rated | - | 1.5 | 110 | μΑ | |
| | | $V_R = V_R$ rated, $T_J = 150$ °C | - | 7 | 250 | | |
| | | V _R = V _R rated, T _J = 175 °C | - | 12 | - | | |
| Total capacitance | С | V _R = 1 V, f = 1 MHz | - | 1200 | =. | pF | |
| | | V _R = 800 V, f = 1 MHz | - | 73 | - | PΓ | |
| Total capacitive charge | Q _C | V _R = 800 V, f = 1 MHz | - | 107 | - | nC | |

| THERMAL - MECHANICAL SPECIFICATIONS (T _A = 25 °C unless otherwise specified) | | | | | | |
|---|-------------------|-----------|---|-----|-----|-------|
| PARAMETER SYMBOL TEST CONDITIONS MIN. TYP. MAX. UNITS | | | | | | UNITS |
| Thermal resistance, junction-to-case | R _{thJC} | | - | 0.6 | 0.8 | °C/W |
| Marking device | | 3C20EP12L | | | | |

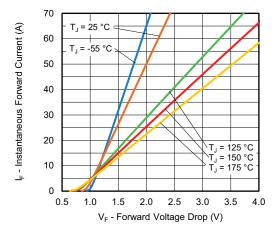


Fig. 1 - Typical Forward Voltage Drop Characteristics

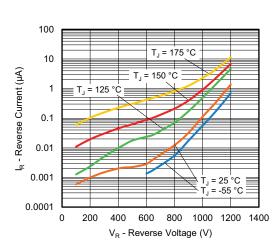


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

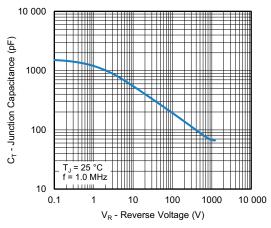


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

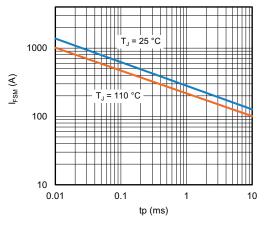


Fig. 4 - Non-Repetitive Peak Forward Surge Current vs. Pulse Duration (Square Wave)



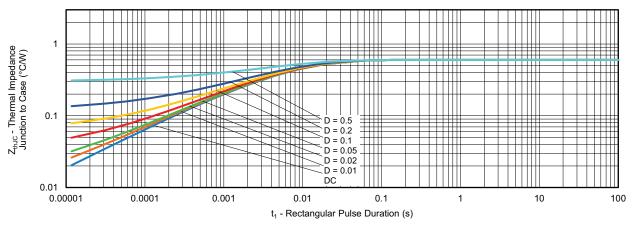


Fig. 5 - Typical Thermal Impedance Z_{thJC} Characteristics

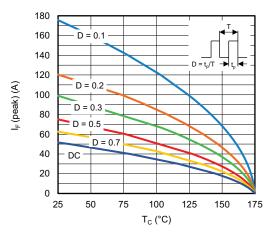


Fig. 6 - Peak Forward Current vs. Maximum Allowable Case Temperature

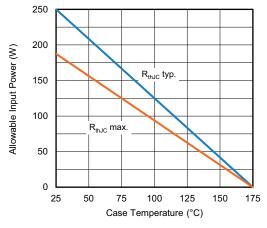


Fig. 7 - Forward Power Loss Characteristics

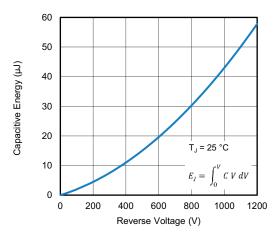


Fig. 8 - Typical Capacitive Energy vs. Reverse Voltage

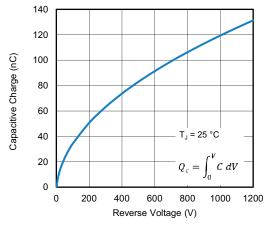
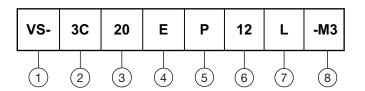


Fig. 9 - Typical Capacitive Charge vs. Reverse Voltage



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - 3C = SiC diode, Generation 3

Current rating (20 = 20 A)

4 - E = single diode

- P = package TO-247

6 - Voltage rating: 12 = 1200 V

7 - L = long lead

8 - Environmental digit:

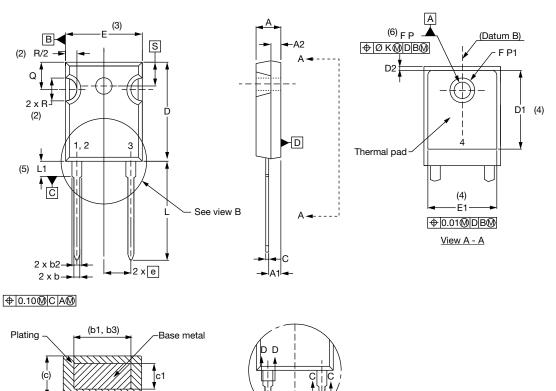
-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

| ORDERING INFORMATION | | |
|----------------------|---------------|--------------------------|
| PREFERRED P/N | BASE QUANTITY | PACKAGING DESCRIPTION |
| VS-3C20EP12L-M3 | 25 / tube | Antistatic plastic tubes |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95536 | | | |
| Part marking information | www.vishay.com/doc?95648 | | | |

TO-247AD 2L

DIMENSIONS in millimeters and inches



View B

| SYMBOL | MILLIN | IETERS | INC | NOTES | |
|---------|--------|--------|-------|-------|-------|
| STWIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |
| D2 | 0.51 | 1.35 | 0.020 | 0.053 | |

Section C - C, D - D

| SYMBOL | MILLIMETERS | | INC | NOTES | |
|----------|-------------|-------|-------|-------|-------|
| STIVIBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Е | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | - | 0.53 | - | |
| е | 5.46 BSC | | 0.215 | BSC | |
| ØK | 0.2 | 0.254 | | 0.010 | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 | 'BSC | |
| | | • | | • | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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